



The 22nd International Symposium on Laser Precision Microfabrication June 8 to June 11, 2021, Web "On-Demand" conference

<http://www.jlps.gr.jp/lpm/lpm2021/>

Organized by Japan Laser Processing Society (JLPS)

SPONSORSHIP OPPORTUNITIES

Welcome to join us at LPM2021!

LPM2021 -The 22nd International Symposium on Laser Precision Microfabrication will be held from June 8 to June 11, 2021. Initially, the organizing committee was planning to hold it in Hirosaki city of Aomori Prefecture, Japan, as a "Real Conference" on site. However, due to the recent context of COVID-19, there is no choice but to do it as "Web-Conference" instead. Considering the time difference, "On-Demand" presentations will be appropriate. At the same time, we will try to seek the possibility on "LIVE Remote presentations at GMT time zone" only for Plenary Session. Oral presentations including invited talks will be done by "On-Demand" method. Traditional poster session will not be arranged this time. Instead of that, Short Note (5 minutes oral presentation) will be welcomed.

Now, we would like to encourage you to become LPM2021 sponsors. We hope that the Sponsorship will strongly assist you to extend your world-wide business opportunities. For the details, please refer to the following pages. Thank you for your attention in advance.

AIM AND SCOPE:

Miniaturization and high precision are rapidly becoming requirements in many industrial processes and products. As a result, there is greater interest in the use of laser micro fabrication approaches to achieve these goals. The International Symposium on Laser Precision Microfabrication (LPM) is alternatively held in Japan and in other host countries. To date, LPM has been successfully hosted in Omiya, Singapore, Osaka, Munich, Nara, Williamsburg, Kyoto, Vienna, Quebec, Kobe, Stuttgart, Takamatsu, Washington D.C., Niigata, Vilnius, Kokura, Xi'an, Toyama, Edinburgh, Hiroshima and Dresden (Web Conference).

The aim of this symposium is to provide a forum for discussion of fundamental aspects of laser-matter interaction, the state-of-the-art of laser materials processing, and topics for the next generation with fundamental scientists, end users and laser manufactures. We expect that LPM2021 would play an important role not only for understanding fundamental knowledge of laser precision microfabrication but also forecasting future technologies to be developed and the future laser market.

Arrangements for all sponsors

1) **Company logo (banner)** will be listed on the LPM2021 website with URL link.

(Example of banner size: Width 184 x Height 60 pixel)

2) **Company name** will be listed on the technical digest.

3) **Free access** for "Proceedings of LPM2021"

The proceedings will be published online after the event.

4) **List of attendees' affiliations** will be sent to the sponsors after the event.

The list does not include the attendees' personal information such as name, e-mail address.

	PLATINUM	GOLD	SILVER	BRONZE
Sponsorship fee	JPY 400000-	JPY 200000-	JPY 100000-	JPY 50000-
Advertisements	A4 sized 2 pages	A4 sized 1 page	A5 sized 1 page	none
Promotional video	2 video (MP4 files 10 minutes each)	1 video (MP4 file 10 minutes)	1 video (MP4 file 3 minutes)	none
Registration	2 persons: Free	1 person: Free	1 person: Free	1 person: Free

JPY= Japanese Yen

Advertisement Guidelines (for Platinum and Gold)

Ad Size: One **A4 sized** ad (Height 297mm x Width 210mm)

Margins: Top/Bottom: Over 20mm, Right/Left: Over 15mm

Language: English is preferable.

File: Fully completed clear PDF file, please. Do not divide texts and figures separately.

Submission: Please send the electric file of ad by e-mail at lpm2021@jlps.gr.jp

Due date: April 30, 2021, JST.

Advertisement Guidelines (for Silver)

Size: One **A5 sized** ad (Half size of A4 sized paper, Height 148mm x Width 210mm)
(Ad orientation with longer horizontal size than vertical)

Margins: Top/Bottom/Right/Left: Over 15mm

Language: English is preferable.

File: Fully completed clear PDF file, please. Do not divide texts and figures separately.

Submission: Please send the electric file of ad by e-mail at lpm2021@jlps.gr.jp

Due date: April 30, 2021, JST.

PAYMENT METHOD (Credit card or Bank wire-transfer):

Payment Due Date: **April 30, 2021, JST**

For Wire-Transfer to LPM2021 Secretariat, Japan Laser Processing Society (JLPS)

Bank name: Sumitomo Mitsui Banking Corporation

Branch: Minami Senri Branch

SWIFT Code: SMBCJPJT

Bank code: #0009

Branch code: #189

Account name: " Ittpan Shadan Hojin Laser Kako Gattkai "

(↑Japanese name of JLPS)

Account type: Regular (Futsu)

Account No.: 1159822

Bank address: 1-2-D9-101, Tsukumodai, Suita-city, Osaka 565-0862, Japan

Bank phone #: +81-6-6833-1911

[Note] Please make sure to add ¥4000 for bank handling fee.

HOW TO APPLY:

Please fill out the application form shown on the next page, and fax or e-mail back to us.

CONTACT:

LPM2021 Secretariat, Japan Laser Processing Society (JLPS)
c/o JWRI, Osaka University, 11-1 Mihogaoka, Ibaraki, Osaka 567-0047, Japan
TEL/FAX: +81-6-6879-8642, E-mail: lpm2021@jlps.gr.jp

LPM2021 SPONSORSHIP APPLICATION FORM

E-mail PDF file to: lpm2021@jlps.gr.jp, or fax to +81-6-6879-8642

Date:	(Month/Date/Year)	Application No		
		(For LPM office use)		
Company Name	(This is for listing on the Technical Digests. Please write your official company name correctly. Do not omit anything such as Co., Ltd.)			
URL for link				
Person in charge				
E-mail Address	(Clearly write under-bar, hyphen, etc.)			
Address	City			
	Country			
Sponsorship Fee	ITEMS	FEE	SUB-TOTAL AMOUNT	
	PLATINUM	JPY 400000-		
	GOLD	JPY 200000-		
	SILVER	JPY 100000-		
	BRONZE	JPY 50000-		
	Sub-Total Amount			JPY
	Bank handling fee for bank wire-transaction			JPY 4,000-
	TOTAL AMOUNT			JPY
Payment to be made on		(Month/Date/Year)		
Card Type (Please circle)	VISA	MASTER		
Credit Card Number				
Expiration	Month/ Year			
Card Holder's Name shown on the credit card				
Card Holder's Signature:				

Note: If you prefer to pay via bank wire-transaction and would like to receive the invoice, please contact us at lpm2021@jlps.gr.jp **If you pay by credit card, please lock the PDF file with password for security reasons.** *Personal information will be used only for administrative procedures and will not be used elsewhere.*